

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

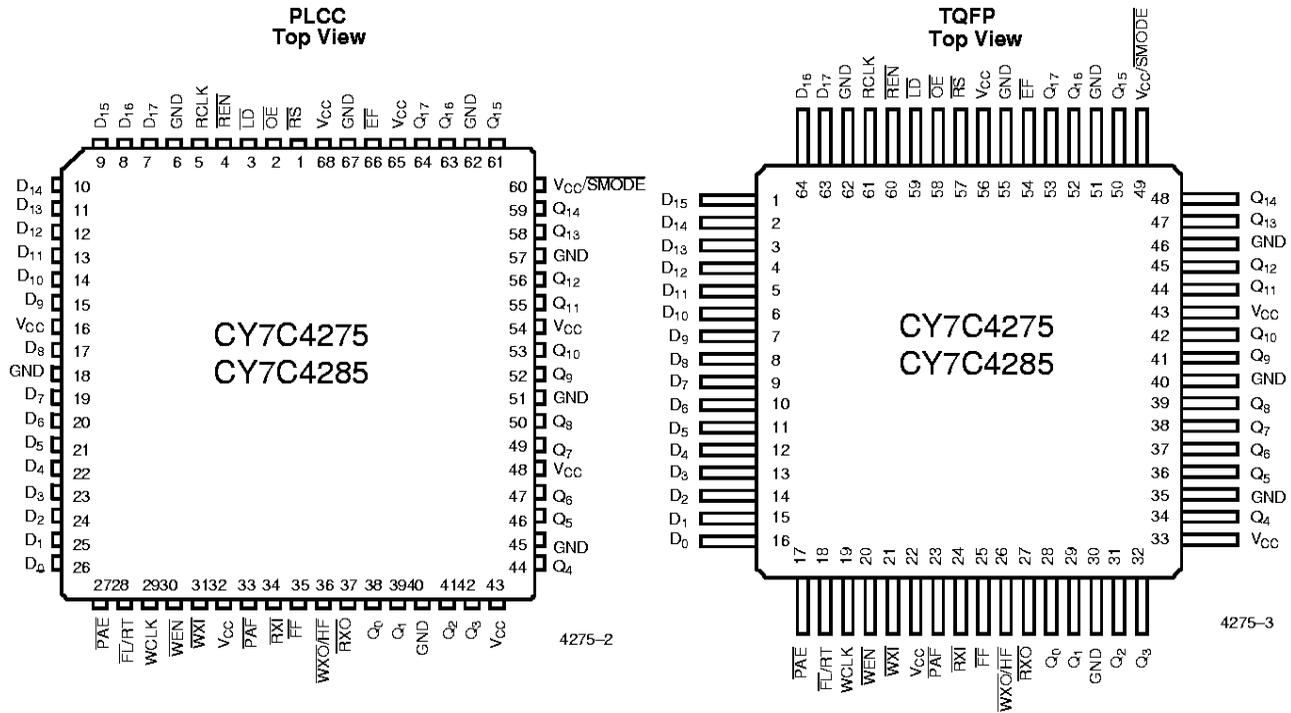
Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

Pin Configurations



Functional Description (continued)

The CY7C4275/85 provides five status pins. These pins are decoded to determine one of five states: Empty, Almost Empty, Half Full, Almost Full, and Full (see *Table 2*). The Half Full flag shares the $\overline{W\!X\!O}$ pin. This flag is valid in the stand-alone and width-expansion configurations. In the depth expansion, this pin provides the expansion out ($\overline{W\!X\!O}$) information that is used to signal the next FIFO when it will be activated.

The Empty and Full flags are synchronous, i.e., they change state relative to either the read clock (RCLK) or the write clock (WCLK). When entering or exiting the Empty states, the flag is updated exclusively by the RCLK. The flag denoting Full states is updated exclusively by WCLK. The synchronous flag architecture guarantees that the flags will remain valid from one clock cycle to the next. The Almost Empty/Almost Full flags become synchronous if the $V_{CC}/S\!M\!O\!D\!E$ is tied to V_{SS} . All configurations are fabricated using an advanced 0.5 μ CMOS technology. Input ESD protection is greater than 2001V, and latch-up is prevented by the use of guard rings.

Selection Guide

		7C4275/85-10	7C4275/85-15	7C4275/85-25	7C4275/85-35
Maximum Frequency (MHz)		100	66.7	40	28.6
Maximum Access Time (ns)		8	10	15	20
Minimum Cycle Time (ns)		10	15	25	35
Minimum Data or Enable Set-Up (ns)		3	4	6	7
Minimum Data or Enable Hold (ns)		0.5	1	1	2
Maximum Flag Delay (ns)		8	10	15	20
Active Power Supply Current (I_{CC1}) (mA)	Commercial	50	50	50	50
	Industrial	55	55	55	55

	CY7C4275	CY7C4285
Density	32K x 18	64K x 18
Package	64-pin 10x10 TQFP 68-pin PLCC	64-pin 10x10 TQFP 68-pin PLCC



Pin Definitions

Signal Name	Description	I/O	Function
D ₀₋₁₇	Data Inputs	I	Data inputs for an 18-bit bus
Q ₀₋₁₇	Data Outputs	O	Data outputs for an 18-bit bus
WEN	Write Enable	I	Enables the WCLK input
REN	Read Enable	I	Enables the RCLK input
WCLK	Write Clock	I	The rising edge clocks data into the FIFO when WEN is LOW and the FIFO is not Full. When LD is asserted, WCLK writes data into the programmable flag-offset register.
RCLK	Read Clock	I	The rising edge clocks data out of the FIFO when REN is LOW and the FIFO is not Empty. When LD is asserted, RCLK reads data out of the programmable flag-offset register.
WXO/HF	Write Expansion Out/Half Full Flag	O	Dual-Mode Pin: Single device or width expansion – Half Full status flag. Cascaded – Write Expansion Out signal, connected to WXI of next device.
EF	Empty Flag	O	When EF is LOW, the FIFO is empty. EF is synchronized to RCLK.
FF	Full Flag	O	When FF is LOW, the FIFO is full. FF is synchronized to WCLK.
PAE	Programmable Almost Empty	O	When PAE is LOW, the FIFO is almost empty based on the almost-empty offset value programmed into the FIFO. PAE is asynchronous when V _{CC} /SMODE is tied to V _{CC} ; it is synchronized to RCLK when V _{CC} /SMODE is tied to V _{SS} .
PAF	Programmable Almost Full	O	When PAF is LOW, the FIFO is almost full based on the almost full offset value programmed into the FIFO. PAF is asynchronous when V _{CC} /SMODE is tied to V _{CC} ; it is synchronized to WCLK when V _{CC} /SMODE is tied to V _{SS} .
LD	Load	I	When LD is LOW, D ₀₋₁₇ (Q ₀₋₁₇) are written (read) into (from) the programmable-flag-offset register.
FL/RT	First Load/Retransmit	I	Dual-Mode Pin: Cascaded – The first device in the daisy chain will have FL tied to V _{SS} ; all other devices will have FL tied to V _{CC} . In standard mode or width expansion, FL is tied to V _{SS} on all devices. Not Cascaded – Tied to V _{SS} . Retransmit function is also available in stand-alone mode by strobing RT.
WXI	Write Expansion Input	I	Cascaded – Connected to WXO of previous device. Not Cascaded – Tied to V _{SS} .
RXI	Read Expansion Input	I	Cascaded – Connected to RXO of previous device. Not Cascaded – Tied to V _{SS} .
RXO	Read Expansion Output	O	Cascaded – Connected to RXI of next device.
RS	Reset	I	Resets device to empty condition. A reset is required before an initial read or write operation after power-up.
OE	Output Enable	I	When OE is LOW, the FIFO's data outputs drive the bus to which they are connected. If OE is HIGH, the FIFO's outputs are in High Z (high-impedance) state.
V _{CC} /SMODE	Synchronous Almost Empty/Almost Full Flags	I	Dual-Mode Pin Asynchronous Almost Empty/Almost Full flags – tied to V _{CC} . Synchronous Almost Empty/Almost Full flags – tied to V _{SS} . (Almost Empty synchronized to RCLK, Almost Full synchronized to WCLK.)



Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

- Storage Temperature -65°C to +150°C
- Ambient Temperature with Power Applied -55°C to +125°C
- Supply Voltage to Ground Potential -0.5V to +7.0V
- DC Voltage Applied to Outputs in High Z State -0.5V to +7.0V
- DC Input Voltage -0.5V to $V_{CC}+0.5V$

- Output Current into Outputs (LOW) 20 mA
- Static Discharge Voltage >2001V (per MIL-STD-883, Method 3015)
- Latch-Up Current >200 mA

Operating Range

Range	Ambient Temperature	V_{CC}
Commercial	0°C to +70°C	5V ± 10%
Industrial ^[1]	-40°C to +85°C	5V ± 10%

Electrical Characteristics Over the Operating Range^[2]

Parameter	Description	Test Conditions	7C42X5-10		7C42X5-15		7C42X5-25		7C42X5-35		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}, I_{OH} = -2.0 \text{ mA}$	2.4		2.4		2.4		2.4		V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}, I_{OL} = 8.0 \text{ mA}$		0.4		0.4		0.4		0.4	V
V_{IH} ^[3]	Input HIGH Voltage		2.0	V_{CC}	2.0	V_{CC}	2.0	V_{CC}	2.0	V_{CC}	V
V_{IL} ^[4]	Input LOW Voltage		-0.5	0.8	-0.5	0.8	-0.5	0.8	-0.5	0.8	V
I_{IX}	Input Leakage Current	$V_{CC} = \text{Max.}$	-10	+10	-10	+10	-10	+10	-10	+10	µA
I_{OZL} I_{OZH}	Output OFF, High Z Current	$\overline{OE} \geq V_{IH}, V_{SS} < V_O < V_{CC}$	-10	+10	-10	+10	-10	+10	-10	+10	µA
I_{CC1} ^[5]	Active Power Supply Current	Com'l		50		50		50		50	mA
		Ind		55		55		55		55	mA
I_{SB} ^[6]	Average Standby Current	Com'l		2		2		2		2	mA
		Ind		2		2		2		2	mA

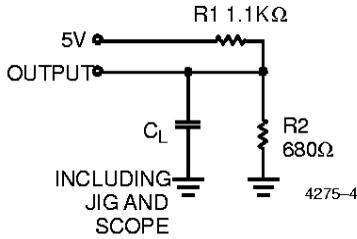
Capacitance^[7]

Parameter	Description	Test Conditions	Max.	Unit
C_{IN}	Input Capacitance	$T_A = 25^\circ\text{C}, f = 1 \text{ MHz}, V_{CC} = 5.0V$	5	pF
C_{OUT}	Output Capacitance		7	pF

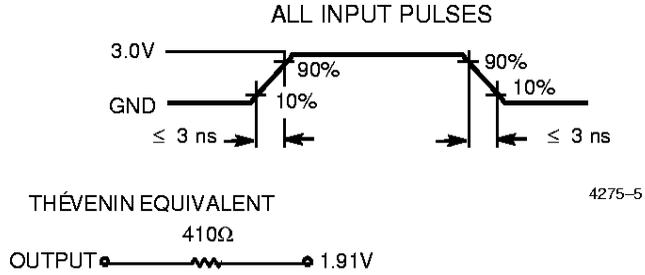
Notes:

1. T_A is the "instant on" case temperature.
2. See the last page of this specification for Group A subgroup testing information.
3. The V_{IH} and V_{IL} specifications apply for all inputs except $\overline{WXI}, \overline{RXI}$. The $\overline{WXI}, \overline{RXI}$ pin is not a TTL input. It is connected to either $\overline{RXO}, \overline{WZO}$ of the previous device or V_{SS} .
4. The V_{IH} and V_{IL} specifications apply for all inputs except $\overline{WXI}, \overline{RXI}$. The $\overline{WXI}, \overline{RXI}$ pin is not a TTL input. It is connected to either $\overline{RXO}, \overline{WZO}$ of the previous device or V_{SS} .
5. Input signals switch from 0V to 3V with a rise/fall time of less than 3 ns, clocks and clock enables switch at 20 MHz, while data inputs switch at 10MHz. Outputs are unloaded. $I_{CC1}(\text{typical}) = (25\text{mA} + (\text{freq} - 20\text{MHz}) * (1.0\text{mA}/\text{MHz}))$
6. All inputs = $V_{CC} - 0.2V$, except RCLK and WCLK (which are at frequency = 0 MHz), and $\overline{FL}/\overline{RT}$ which is at V_{SS} . All outputs are unloaded.
7. Tested initially and after any design changes that may affect these parameters.

AC Test Loads and Waveforms^[8, 9]



Equivalent to:



Switching Characteristics Over the Operating Range

Parameter	Description	7C42X5-10		7C42X5-15		7C42X5-25		7C42X5-35		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_S	Clock Cycle Frequency		100		66.7		40		28.6	MHz
t_A	Data Access Time	2	8	2	10	2	15	2	20	ns
t_{CLK}	Clock Cycle Time	10		15		25		35		ns
t_{CLKH}	Clock HIGH Time	4.5		6		10		14		ns
t_{CLKL}	Clock LOW Time	4.5		6		10		14		ns
t_{DS}	Data Set-Up Time	3		4		6		7		ns
t_{DH}	Data Hold Time	0.5		1		1		2		ns
t_{ENS}	Enable Set-Up Time	3		4		6		7		ns
t_{ENH}	Enable Hold Time	0.5		1		1		2		ns
t_{RS}	Reset Pulse Width ^[10]	10		15		25		35		ns
t_{RSR}	Reset Recovery Time	8		10		15		20		ns
t_{RSF}	Reset to Flag and Output Time		10		15		25		35	ns
t_{PRT}	Retransmit Pulse Width	60		60		60		60		ns
t_{RTR}	Retransmit Recovery Time	90		90		90		90		ns
t_{OLZ}	Output Enable to Output in Low Z ^[12]	0		0		0		0		ns
t_{OE}	Output Enable to Output Valid	3	7	3	8	3	12	3	15	ns
t_{OHZ}	Output Enable to Output in High Z ^[11]	3	7	3	8	3	12	3	15	ns
t_{WFF}	Write Clock to Full Flag		8		10		15		20	ns
t_{REF}	Read Clock to Empty Flag		8		10		15		20	ns
$t_{PAFasynch}$	Clock to Programmable Almost-Full Flag ^[13] (Asynchronous mode, $V_{CC}/SMODE$ tied to V_{CC})		15		16		20		25	ns
$t_{PAFsynch}$	Clock to Programmable Almost-Full Flag (Synchronous mode, $V_{CC}/SMODE$ tied to V_{SS})		8		10		15		20	ns
$t_{PAEasynch}$	Clock to Programmable Almost-Empty Flag ^[12] (Asynchronous mode, $V_{CC}/SMODE$ tied to V_{CC})		15		16		20		25	ns

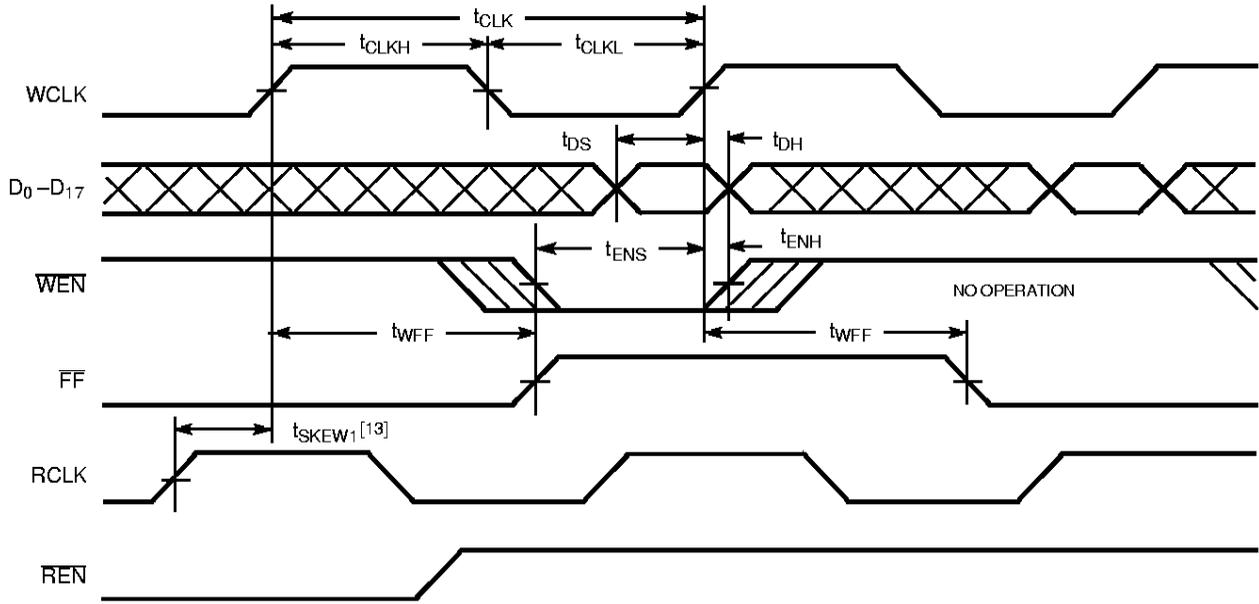
Notes:

- 8. $C_L = 30$ pF for all AC parameters except for t_{OHZ} .
- 9. $C_L = 5$ pF for t_{OHZ} .
- 10. Pulse widths less than minimum values are not allowed.
- 11. Values guaranteed by design, not currently tested.
- 12. $t_{PAFasynch}$, $t_{PAEasynch}$, after program register write will not be valid until 5 ns + $t_{PAF(E)}$.

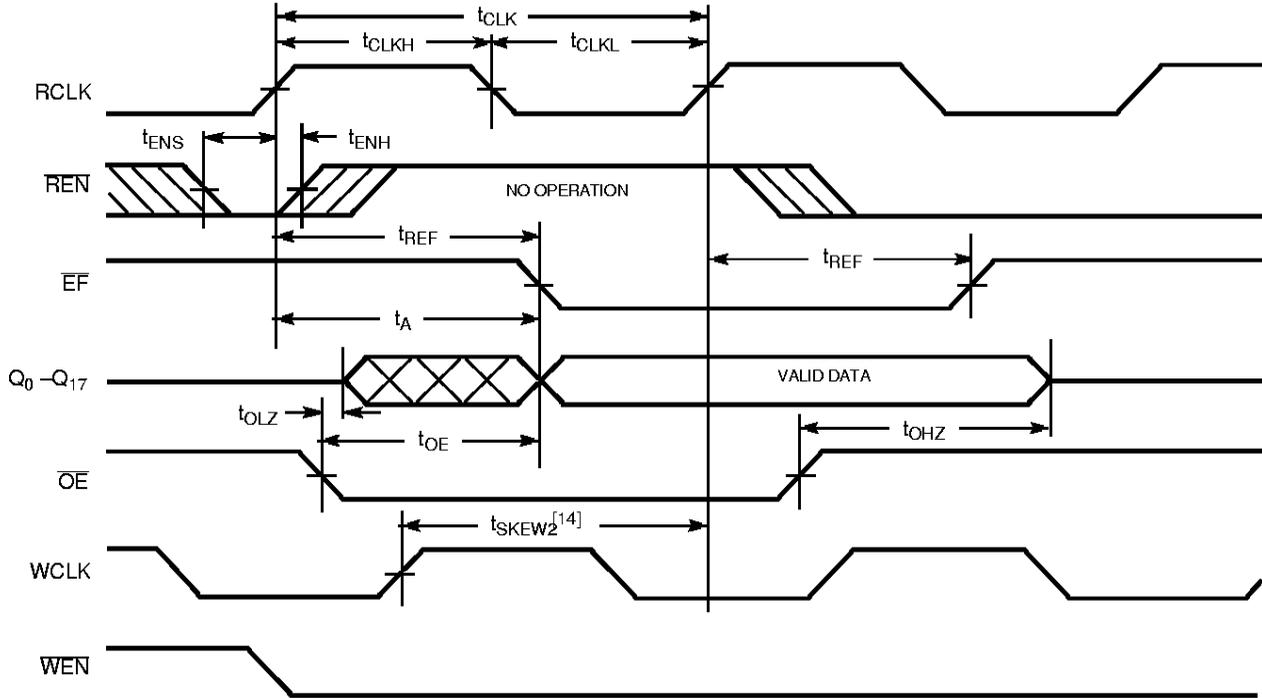


Switching Characteristics Over the Operating Range (continued)

Parameter	Description	7C42X5-10		7C42X5-15		7C42X5-25		7C42X5-35		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{PAEsynch}	Clock to Programmable Almost-Full Flag (Synchronous mode, V _{CC} /SMODE tied to V _{SS})		8		10		15		20	ns
t _{HF}	Clock to Half-Full Flag		12		16		20		25	ns
t _{XO}	Clock to Expansion Out		6		10		15		20	ns
t _{XI}	Expansion in Pulse Width	4.5		6.5		10		14		ns
t _{XIS}	Expansion in Set-Up Time	4		5		10		15		ns
t _{SKEW1}	Skew Time between Read Clock and Write Clock for Full Flag	5		6		10		12		ns
t _{SKEW2}	Skew Time between Read Clock and Write Clock for Empty Flag	5		6		10		12		ns
t _{SKEW3}	Skew Time between Read Clock and Write Clock for Programmable Almost Empty and Programmable Almost Full Flags (Synchronous Mode only)	10		15		18		20		ns

Switching Waveforms
Write Cycle Timing


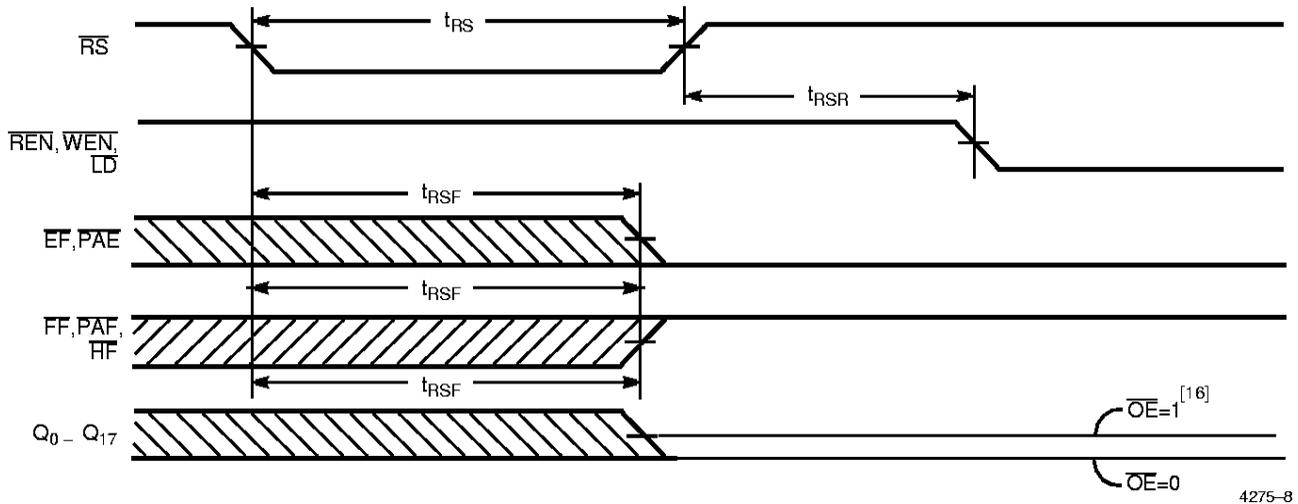
4275-6

Read Cycle Timing


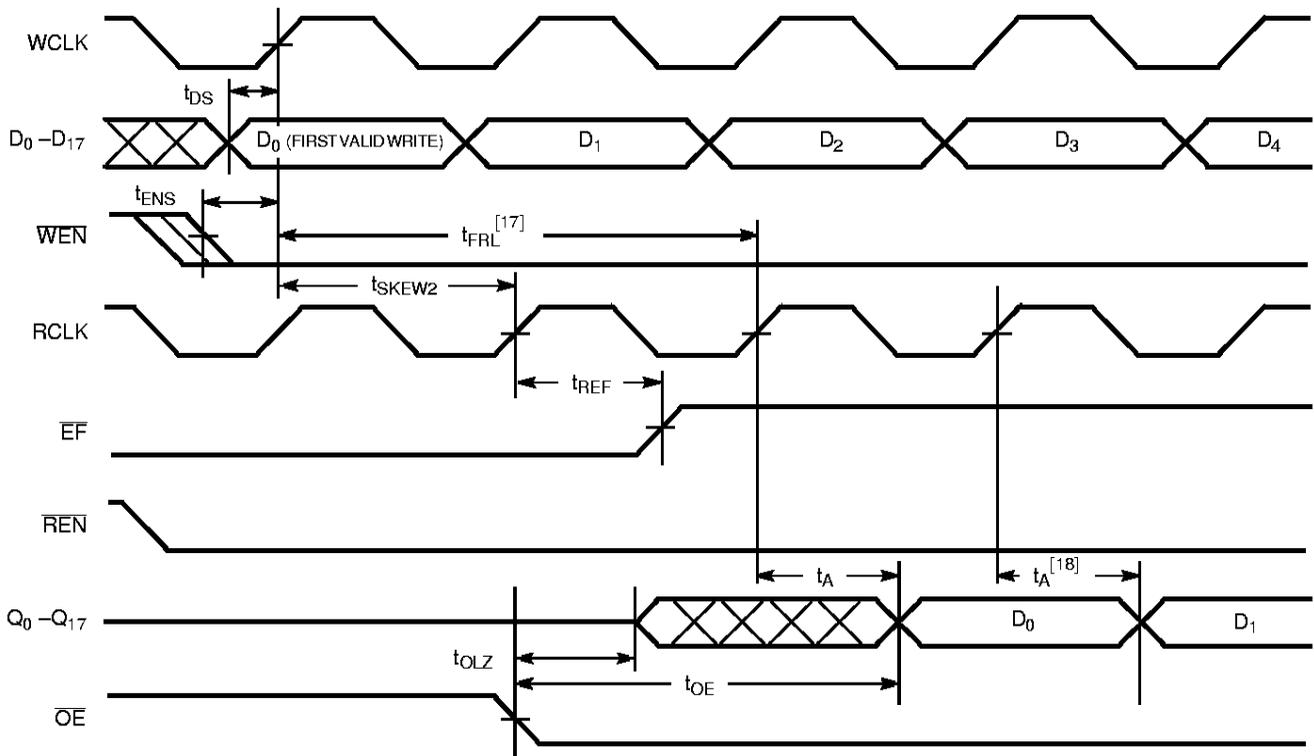
4275-7

Notes:

13. $t_{SKEW1}^{[13]}$ is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF will go HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than $t_{SKEW1}^{[13]}$, then FF may not change state until the next WCLK rising edge.
14. $t_{SKEW2}^{[14]}$ is the minimum time between a rising WCLK edge and a rising RCLK edge to guarantee that EF will go HIGH during the current clock cycle. If the time between the rising edge of WCLK and the rising edge of RCLK is less than $t_{SKEW2}^{[14]}$, then EF may not change state until the next RCLK rising edge.

Switching Waveforms (continued)
Reset Timing [15]


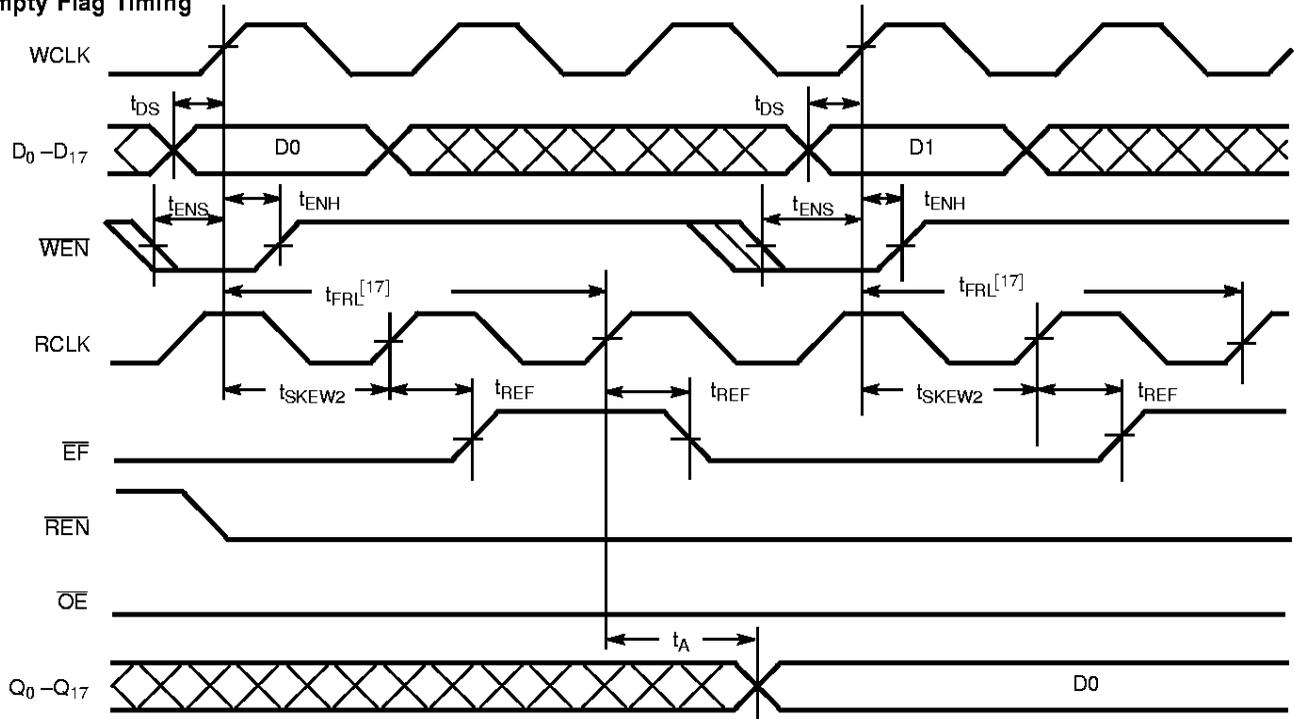
4275-8

First Data Word Latency after Reset with Simultaneous Read and Write


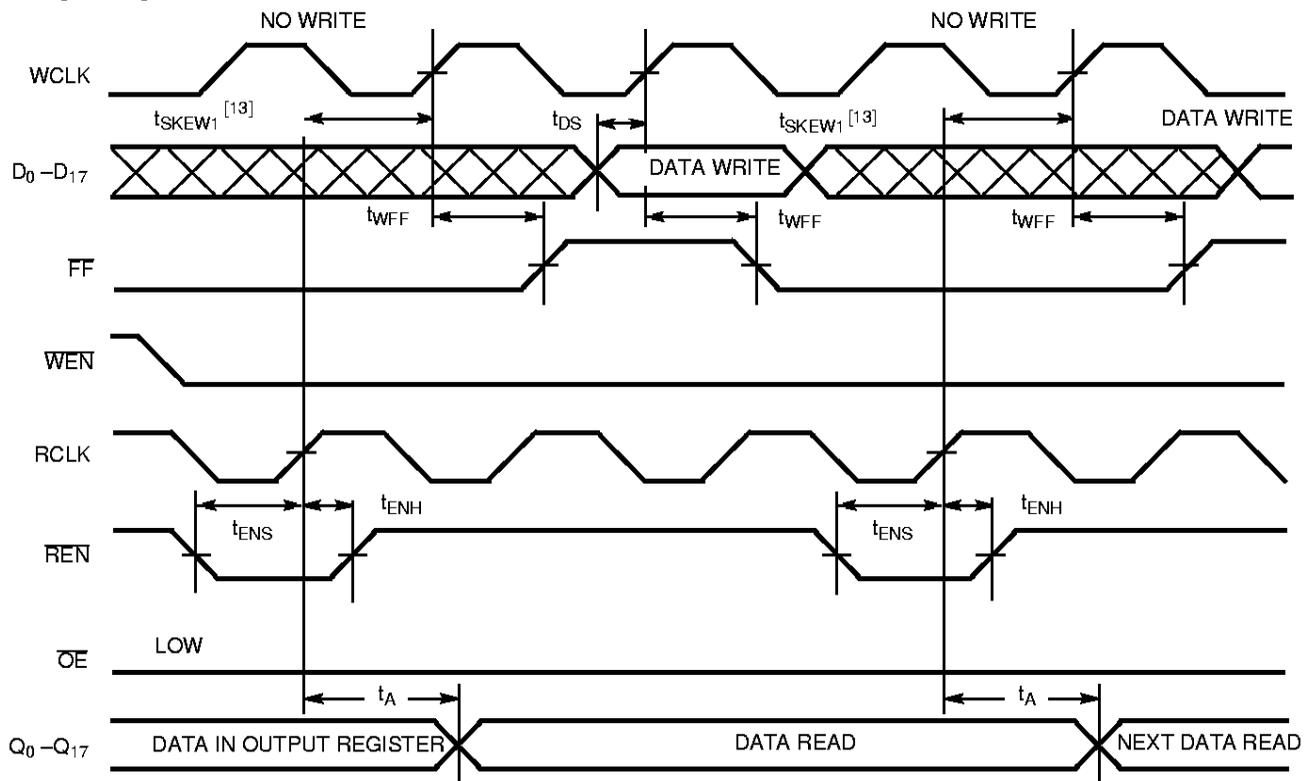
4275-9

Notes:

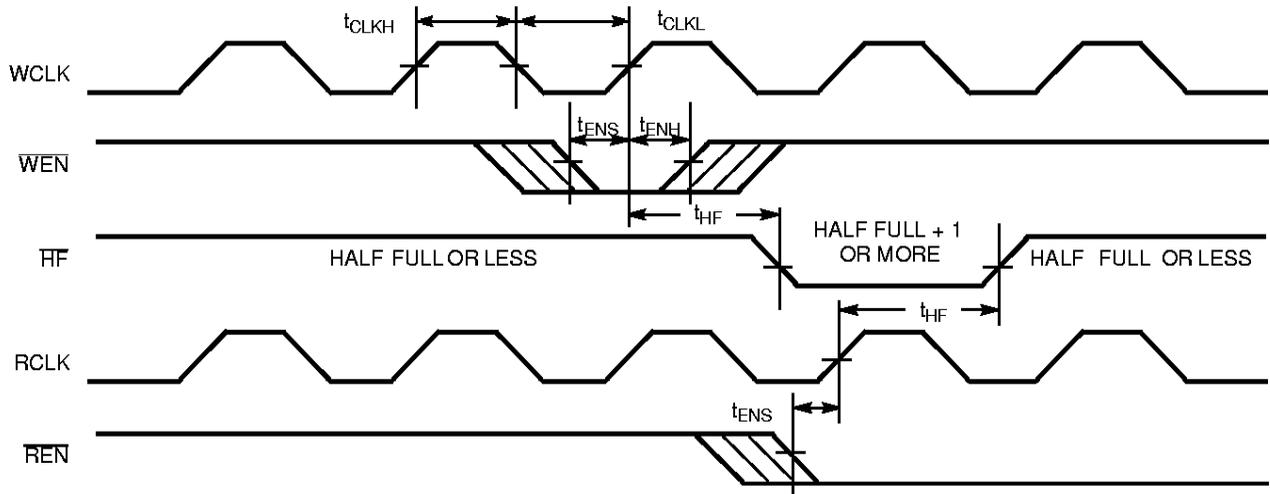
15. The clocks (RCLK, WCLK) can be free-running during reset.
16. After reset, the outputs will be LOW if $\overline{OE} = 0$ and three-state if $\overline{OE} = 1$.
17. When $t_{SKEW2} \geq$ minimum specification, t_{FRL} (maximum) = $t_{CLK} + t_{SKEW2}$. When $t_{SKEW2} <$ minimum specification, t_{FRL} (maximum) = either $2 \cdot t_{CLK} + t_{SKEW2}$ or $t_{CLK} + t_{SKEW2}$. The Latency Timing applies only at the Empty Boundary (EF = LOW).
18. The first word is available the cycle after EF goes HIGH, always.

Switching Waveforms (continued)
Empty Flag Timing


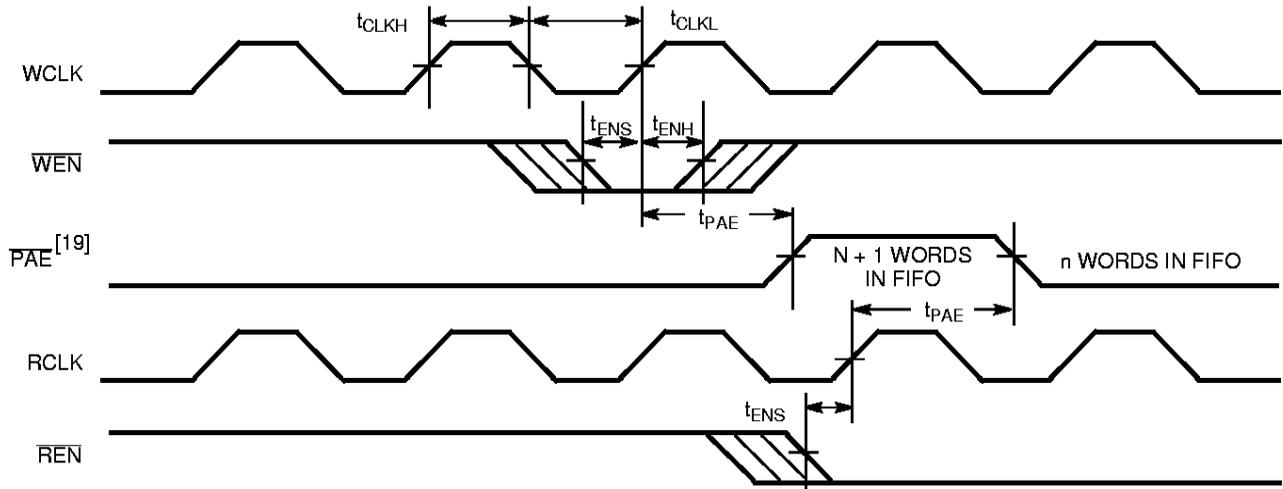
4275-10

Full Flag Timing


4275-11

Switching Waveforms (continued)
Half-Full Flag Timing


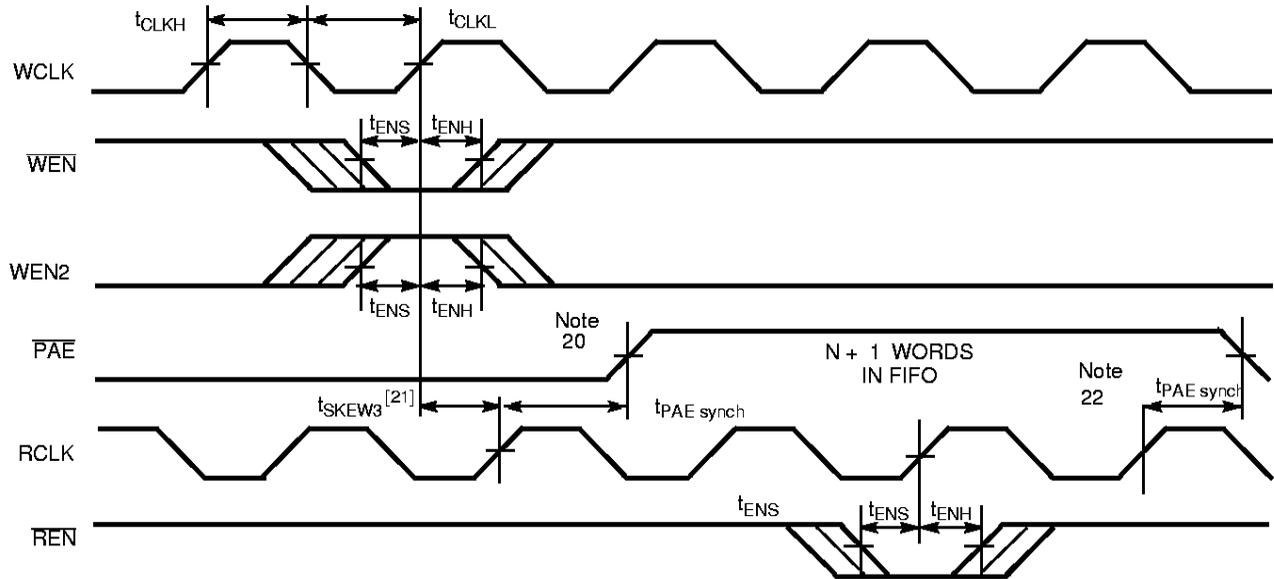
4275-12

Programmable Almost Empty Flag Timing


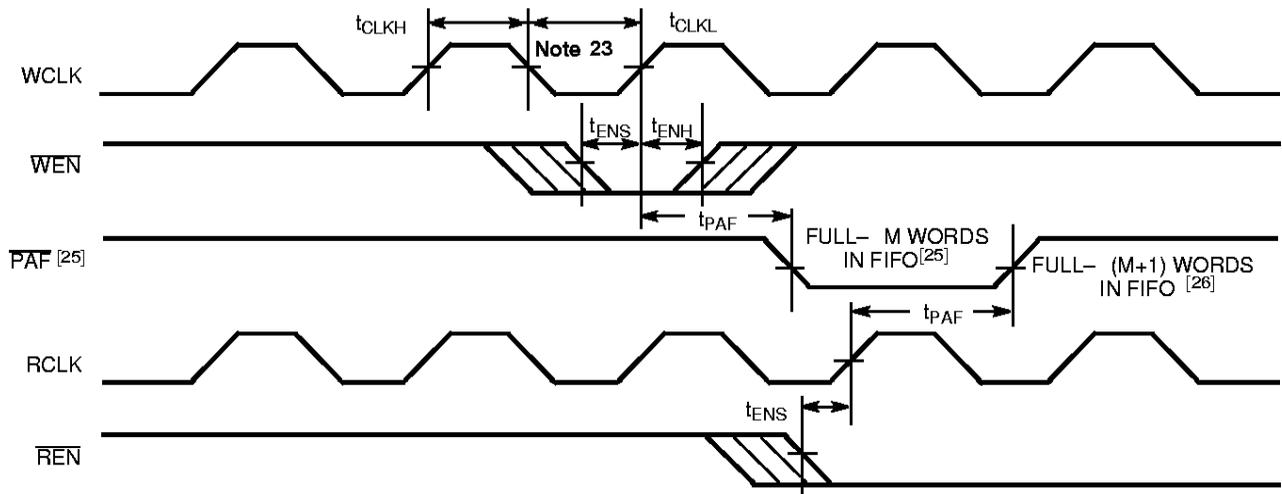
4275-13

Note:

19. PAE is offset = n. Number of data words into FIFO already = n.

Switching Waveforms (continued)
Programmable Almost Empty Flag Timing (applies only in SMODE (SMODE is LOW))


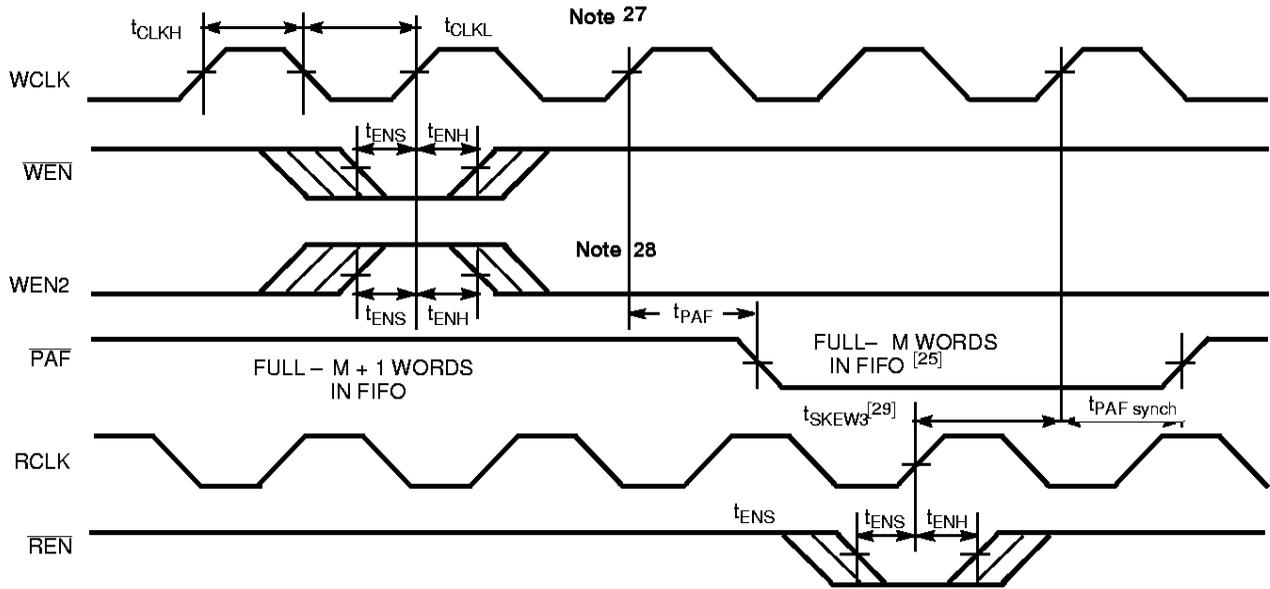
4275-14

Programmable Almost Full Flag Timing


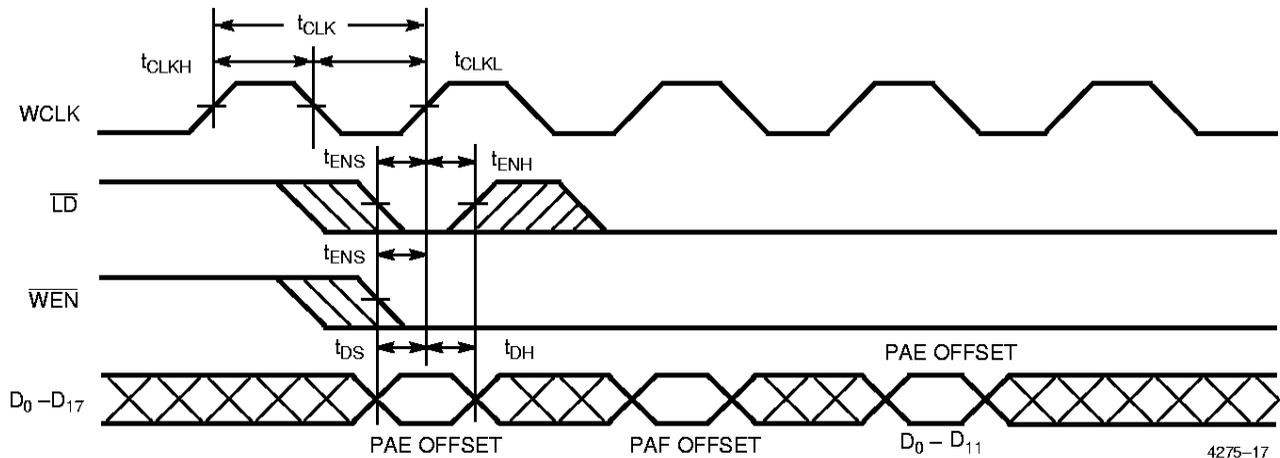
4275-15

Notes:

20. PAE offset = n.
21. t_{SKEW3} is the minimum time between a rising WCLK and a rising RCLK edge for PAE to change state during that clock cycle. If the time between the edge of WCLK and the rising RCLK is less than t_{SKEW3} , then PAE may not change state until the next RCLK.
22. If a read is preformed on this rising edge of the read clock, there will be Empty + (n-1) words in the FIFO when PAE goes LOW.
23. PAF offset = m. Number of data words written into FIFO already = 32768 - (m + 1) for the CY7C4285 and 65536 - (m + 1) for the CY7C4285.
24. PAF is offset = m.
25. 32768 - m words in CY7C4275 and 65536 - m words in CY7C4285.
26. 32768 - (m + 1) words in CY7C4275 and 65536 - (m + 1) CY7C4285.

Switching Waveforms (continued)
Programmable Almost Full Flag Timing (applies only in SMODE (SMODE is LOW))


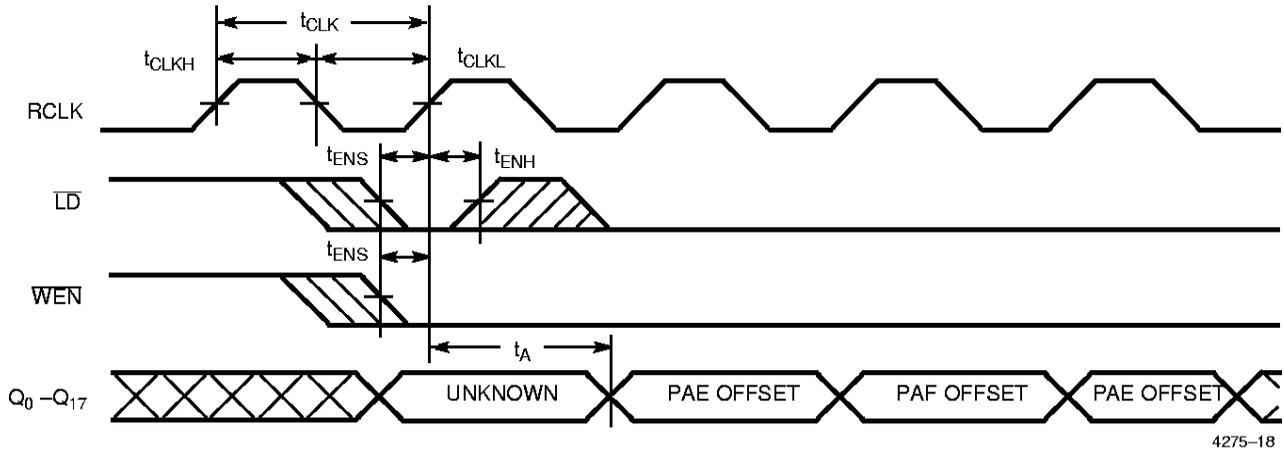
4275-16

Write Programmable Registers


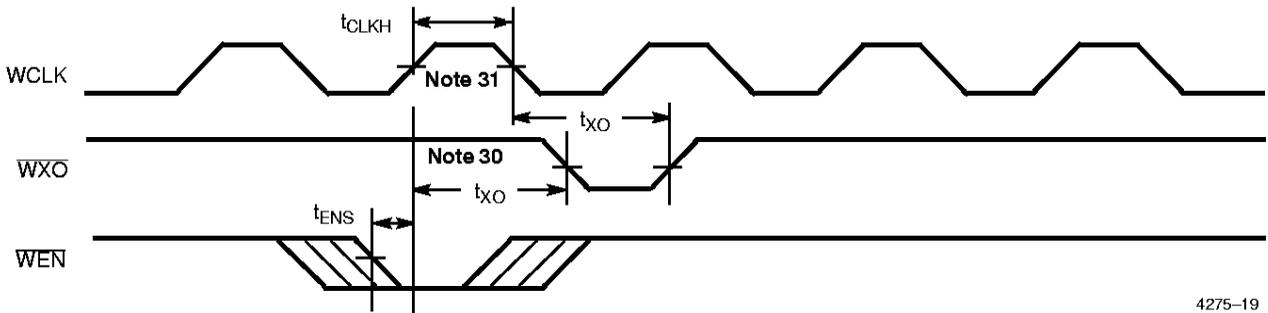
4275-17

Notes:

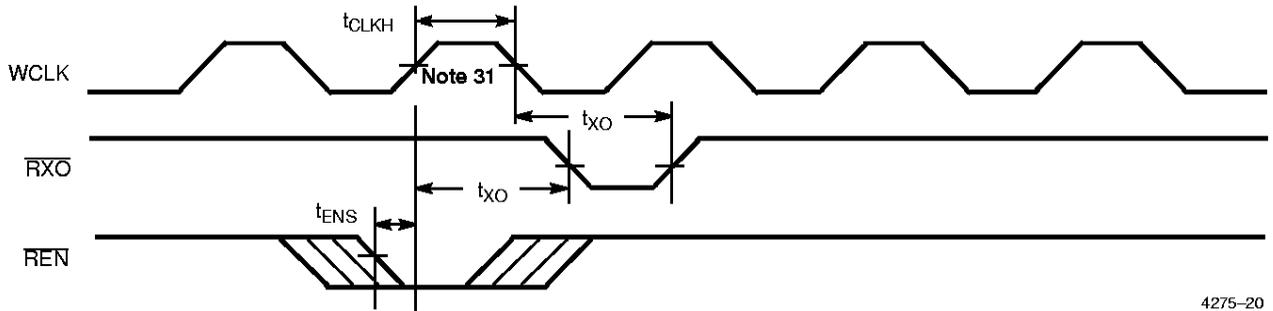
27. If a write is performed on this rising edge of the write clock, there will be Full - (m-1) words of the FIFO when PAF goes LOW.
28. PAF offset = m.
29. t_{SKEW3} is the minimum time between a rising RCLK and a rising WCLK edge for PAF to change state during that clock cycle. If the time between the edge of RCLK and the rising edge of WCLK is less than t_{SKEW3} , then PAF may not change state until the next WCLK rising edge.

Switching Waveforms (continued)
Read Programmable Registers


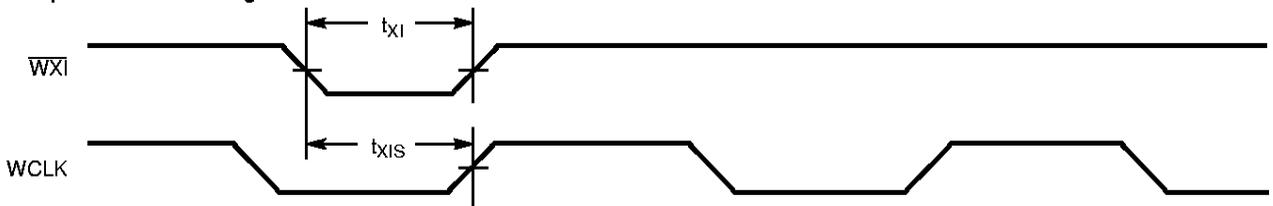
4275-18

Write Expansion Out Timing


4275-19

Read Expansion Out Timing


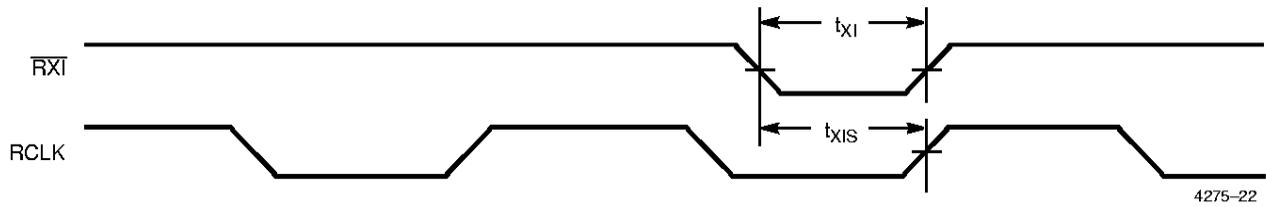
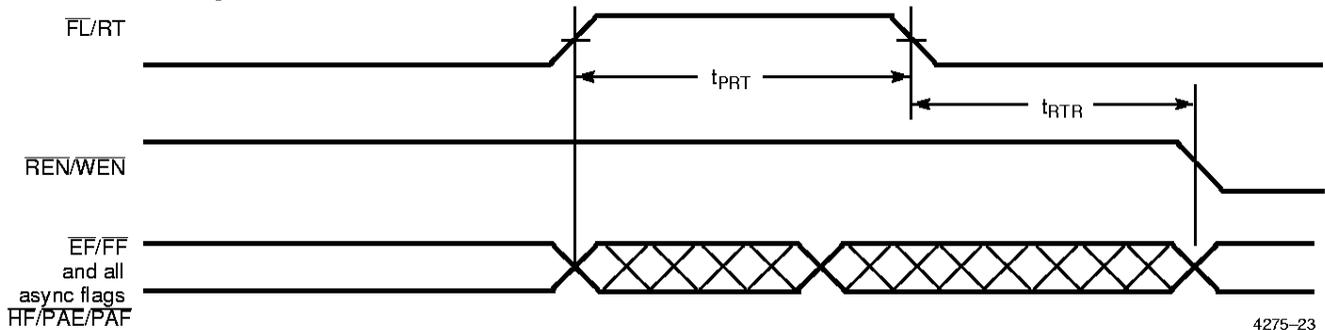
4275-20

Write Expansion In Timing


4275-21

Notes:

- 30. Write to Last Physical Location.
- 31. Read from Last Physical Location.

Switching Waveforms (continued)
Read Expansion In Timing

Retransmit Timing ^[32, 33, 34]

Notes:

- 32. Clocks are free running in this case.
- 33. The flags may change state during Retransmit as a result of the offset of the read and write pointers, but flags will be valid at t_{RTR} .
- 34. For the synchronous PAE and PAF flags (SMODE), an appropriate clock cycle is necessary after t_{RTR} to update these flags.

Architecture

The CY7C4275/85 consists of an array of 32K/64K words of 18 bits each (implemented by a dual-port array of SRAM cells), a read pointer, a write pointer, control signals (RCLK, WCLK, REN, WEN, RS), and flags (EF, PAE, HF, PAF, FF). The CY7C4275/85 also includes the control signals WXI, RXI, WXO, RXO for depth expansion.

Resetting the FIFO

Upon power-up, the FIFO must be reset with a Reset (\overline{RS}) cycle. This causes the FIFO to enter the Empty condition signified by \overline{EF} being LOW. All data outputs go LOW after the falling edge of \overline{RS} only if \overline{OE} is asserted. In order for the FIFO to reset to its default state, a falling edge must occur on \overline{RS} and the user must not read or write while \overline{RS} is LOW.

FIFO Operation

When the \overline{WEN} signal is active (LOW), data present on the D_{0-17} pins is written into the FIFO on each rising edge of the WCLK signal. Similarly, when the \overline{REN} signal is active LOW, data in the FIFO memory will be presented on the Q_{0-17} outputs. New data will be presented on each rising edge of RCLK while \overline{REN} is active LOW and \overline{OE} is LOW. \overline{REN} must set up t_{ENS} before RCLK for it to be a valid read function. \overline{WEN} must occur t_{ENS} before WCLK for it to be a valid write function.

An output enable (\overline{OE}) pin is provided to three-state the Q_{0-17} outputs when \overline{OE} is deasserted. When \overline{OE} is enabled (LOW), data in the output register will be available to the Q_{0-17} outputs after t_{OE} . If devices are cascaded, the \overline{OE} function will only output data on the FIFO that is read enabled.

The FIFO contains overflow circuitry to disallow additional writes when the FIFO is full, and under flow circuitry to disallow additional reads when the FIFO is empty. An empty FIFO maintains the data of the last valid read on its Q_{0-17} outputs even after additional reads occur.

Programming

The CY7C4275/85 devices contain two 16-bit offset registers. Data present on D_{0-15} during a program write will determine the distance from Empty (Full) that the Almost Empty (Almost Full) flags become active. If the user elects not to program the FIFO's flags, the default offset values are used (see *Table 2*). When the Load \overline{LD} pin is set LOW and \overline{WEN} is set LOW, data on the inputs D_{0-15} is written into the Empty offset register on the first LOW-to-HIGH transition of the write clock (WCLK). When the \overline{LD} pin and \overline{WEN} are held LOW then data is written into the Full offset register on the second LOW-to-HIGH transition of the write clock (WCLK). The third transition of the write clock (WCLK) again writes to the Empty offset register (see *Table 1*). Writing all offset registers does not have to occur at one time. One or two offset registers can be written and then, by bringing the \overline{LD} pin HIGH, the FIFO is returned to normal read/write operation.

Note:

35. The same selection sequence applies to reading from the registers. \overline{REN} is enabled and read is performed on the LOW-to-HIGH transition of RCLK.

ation. When the \overline{LD} pin is set LOW, and \overline{WEN} is LOW, the next offset register in sequence is written.

The contents of the offset registers can be read on the output lines when the \overline{LD} pin is set LOW and \overline{REN} is set LOW; then, data can be read on the LOW-to-HIGH transition of the read clock (RCLK).

Table 1. Write Offset Register.

\overline{LD}	\overline{WEN}	WCLK ^[35]	Selection
0	0		Writing to offset registers: Empty Offset Full Offset 
0	1		No Operation
1	0		Write Into FIFO
1	1		No Operation

Flag Operation

The CY7C4275/85 devices provide five flag pins to indicate the condition of the FIFO contents. Empty and Full are synchronous. PAE and PAF are synchronous if $V_{CC}/SMODE$ is tied to V_{SS} .

Full Flag

The Full Flag (\overline{FF}) will go LOW when device is Full. Write operations are inhibited whenever \overline{FF} is LOW regardless of the state of \overline{WEN} . \overline{FF} is synchronized to WCLK, i.e., it is exclusively updated by each rising edge of WCLK.

Empty Flag

The Empty Flag (\overline{EF}) will go LOW when the device is empty. Read operations are inhibited whenever \overline{EF} is LOW, regardless of the state of \overline{REN} . \overline{EF} is synchronized to RCLK, i.e., it is exclusively updated by each rising edge of RCLK.

Programmable Almost Empty/Almost Full Flag

The CY7C4275/85 features programmable Almost Empty and Almost Full Flags. Each flag can be programmed (described in the Programming section) a specific distance from the corresponding boundary flags (Empty or Full). When the FIFO contains the number of words or fewer for which the flags have been programmed, the PAF or PAE will be asserted, signifying that the FIFO is either Almost Full or Almost Empty. See *Table 2* for a description of programmable flags.

When the \overline{SMODE} pin is tied LOW, the \overline{PAF} flag signal transition is caused by the rising edge of the write clock and the \overline{PAE} flag transition is caused by the rising edge of the read clock.



Retransmit

The retransmit feature is beneficial when transferring packets of data. It enables the receipt of data to be acknowledged by the receiver and retransmitted if necessary.

The Retransmit (RT) input is active in the stand-alone and width expansion modes. The retransmit feature is intended for use when a number of writes equal to or less than the depth of the FIFO have occurred and at least one word has been read since the last RS cycle. A HIGH pulse on RT resets the inter-

nal read pointer to the first physical location of the FIFO. WCLK and RCLK may be free running but must be disabled during and t_{RTR} after the retransmit pulse. With every valid read cycle after retransmit, previously accessed data is read and the read pointer is incremented until it is equal to the write pointer. Flags are governed by the relative locations of the read and write pointers and are updated during a retransmit cycle. Data written to the FIFO after activation of RT are transmitted also.

The full depth of the FIFO can be repeatedly retransmitted.

Table 2. Flag Truth Table.

Number of Words in FIFO		FF	PAF	HF	PAE	EF
7C4275 – 32K x 18	7C4285 – 64K x 18					
0	0	H	H	H	L	L
1 to $n^{[36]}$	1 to $n^{[36]}$	H	H	H	L	H
(n+1) to 16384	(n+1) to 32768	H	H	H	H	H
16385 to (32768-(m+1))	32769 to (65536 -(m+1))	H	H	L	H	H
(32768-m) ^[37] to 32767	(65536-m) ^[37] to 65535	H	L	L	H	H
32768	65536	L	L	L	H	H

Notes:

36. n = Empty Offset (Default Values: CY7C4275/CY7C4285 n = 127).

37. m = Full Offset (Default Values: CY7C4275/CY7C4285 n = 127).

Width Expansion Configuration

The CY7C4275/85 can be expanded in width to provide word widths greater than 18 in increments of 18. During width expansion mode all control line inputs are common and all flags are available. Empty (Full) flags should be created by ANDing

the Empty (Full) flags of every FIFO; the $\overline{\text{PAE}}$ and $\overline{\text{PAF}}$ flags can be detected from any one device. This technique will avoid reading data from, or writing data to the FIFO that is "staggered" by one clock cycle due to the variations in skew between RCLK and WCLK. *Figure 1* demonstrates a 36-word width by using two CY7C4275/85s.

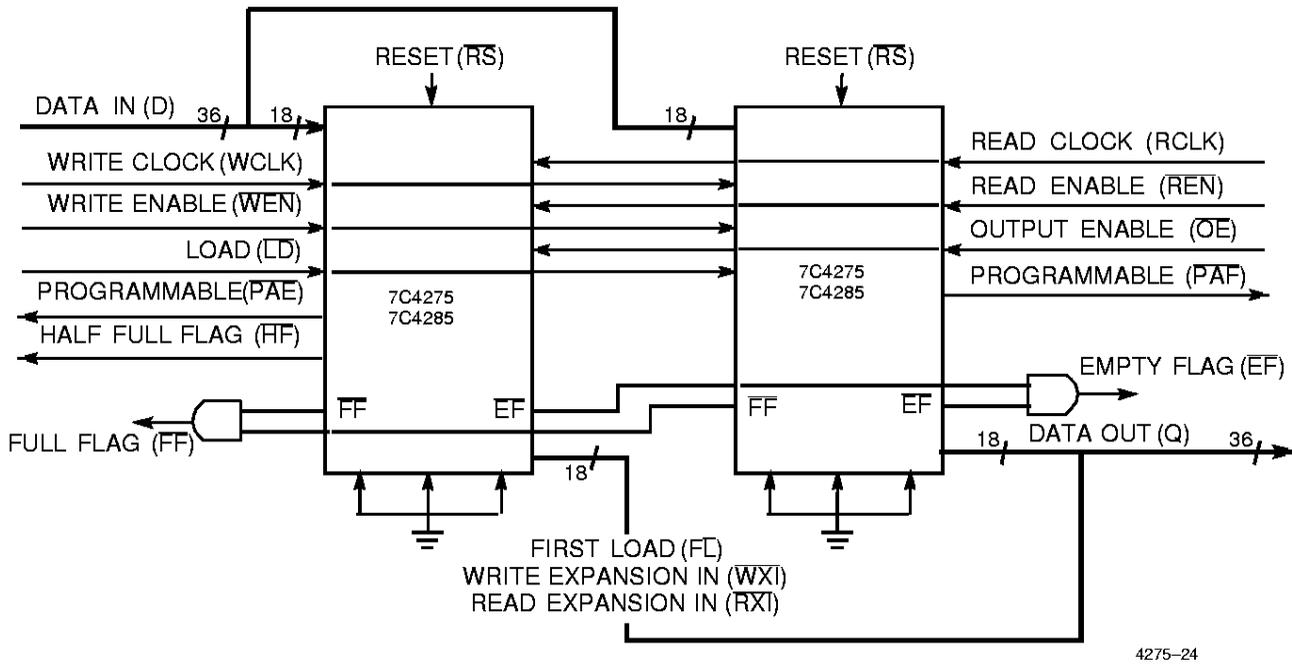
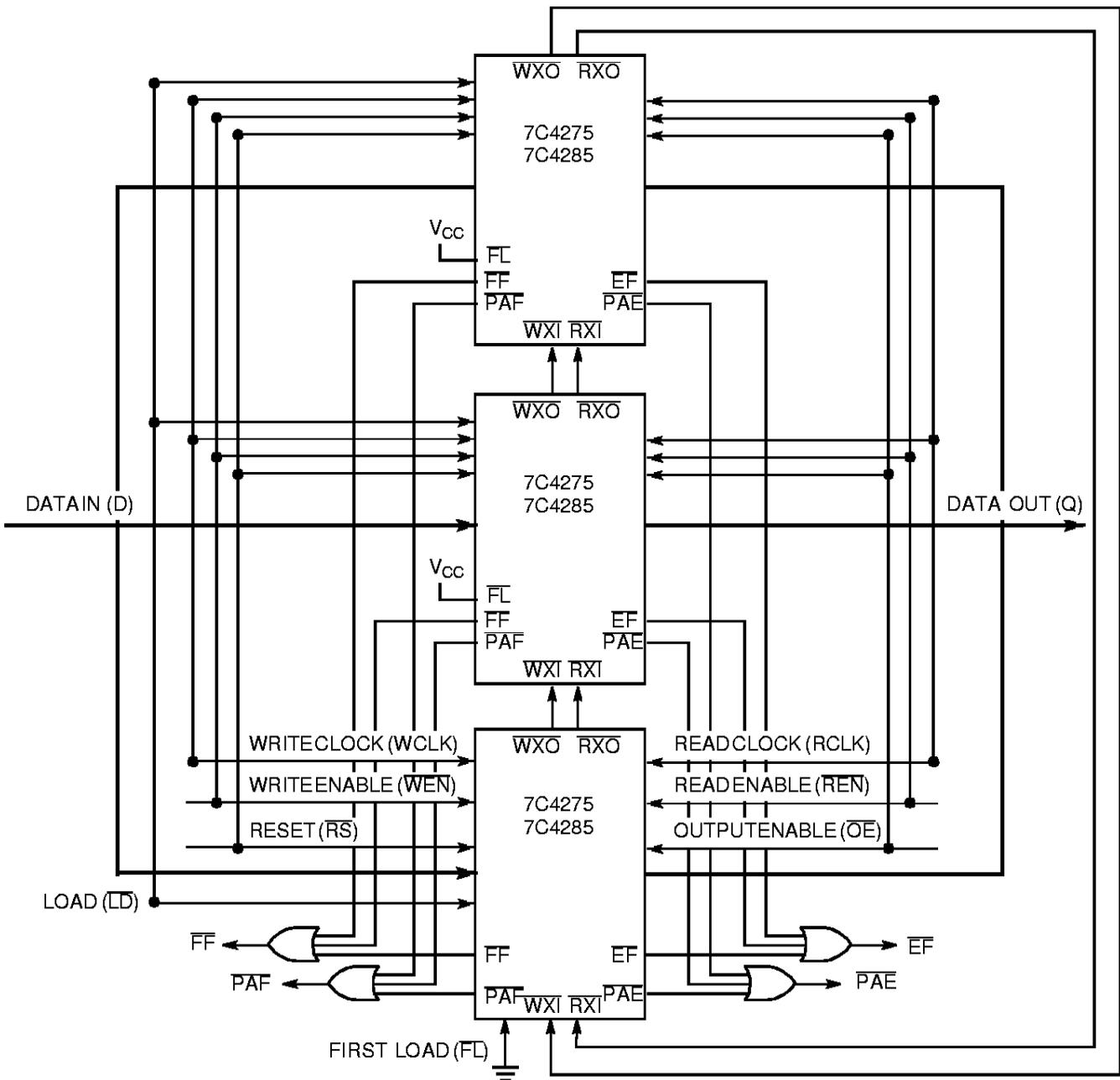


Figure 1. Block Diagram of 32K x18/64K x 18 Synchronous FIFO Memory Used in a Width Expansion Configuration.

Depth Expansion Configuration (with Programmable Flags)

The CY7C4275/85 can easily be adapted to applications requiring more than 32768/65536 words of buffering. Figure 2 shows Depth Expansion using three CY7C42X5s. Maximum depth is limited only by signal loading. Follow these steps:

1. The first device must be designated by grounding the First Load (\overline{FL}) control input.
2. All other devices must have \overline{FL} in the HIGH state.
3. The Write Expansion Out (\overline{WXO}) pin of each device must be tied to the Write Expansion In (\overline{WXI}) pin of the next device.
4. The Read Expansion Out (\overline{RXO}) pin of each device must be tied to the Read Expansion In (\overline{RXI}) pin of the next device.
5. All Load (\overline{LD}) pins are tied together.
6. The Half-Full Flag (\overline{HF}) is not available in the Depth Expansion Configuration.
7. \overline{EF} , \overline{FF} , \overline{PAE} , and \overline{PAF} are created with composite flags by ORing together these respective flags for monitoring. The composite \overline{PAE} and \overline{PAF} flags are not precise.



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Figure 2. Block Diagram of 32Kx18/64Kx18 Synchronous FIFO Memory with Programmable Flags used in Depth Expansion Configuration.



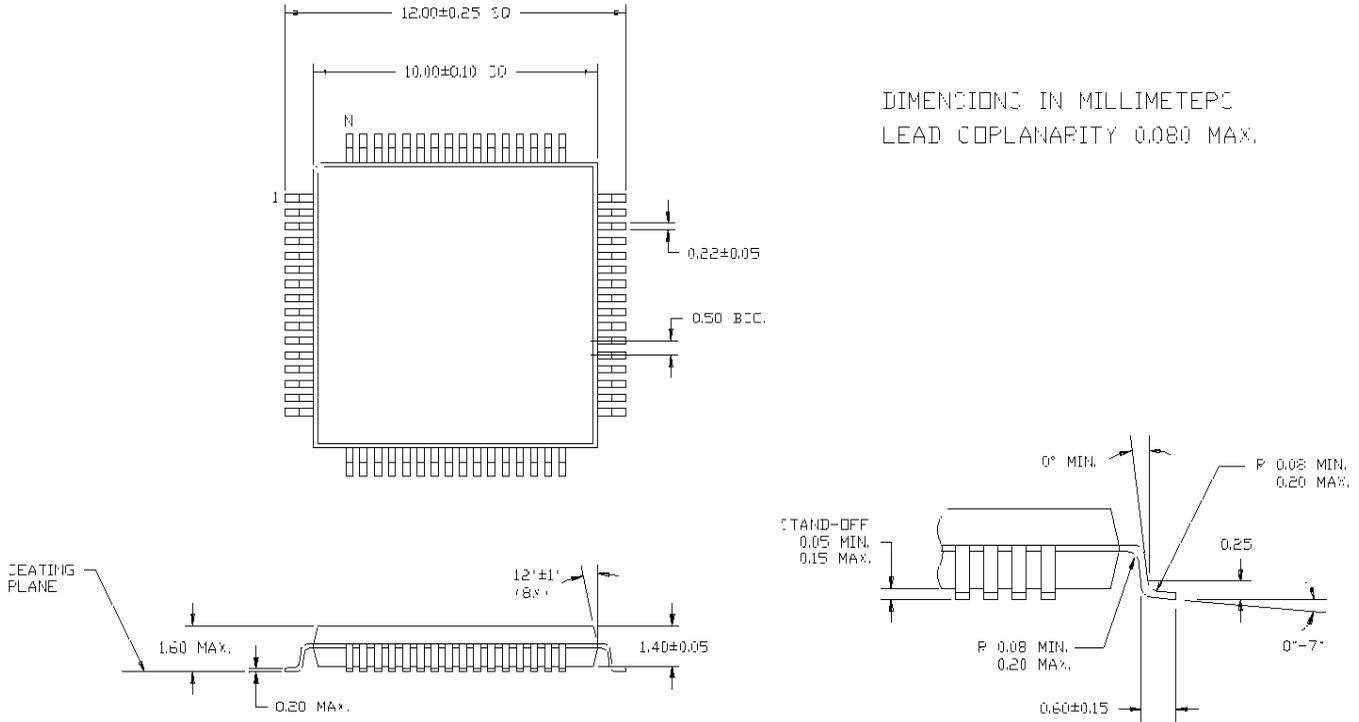
Ordering Information

32Kx18 1 Meg Deep Sync FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4275-10ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4275-10JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4275-10ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4275-10JI	J81	68-Lead Plastic Leaded Chip Carrier	
15	CY7C4275-15ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4275-15JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4275-15ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4275-15JI	J81	68-Lead Plastic Leaded Chip Carrier	
25	CY7C4275-25ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4275-25JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4275-25ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4275-25JI	J81	68-Lead Plastic Leaded Chip Carrier	
35	CY7C4275-35ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4275-35JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4275-35ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4275-35JI	J81	68-Lead Plastic Leaded Chip Carrier	

64Kx18 1 Meg Deep Sync FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4285-10ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4285-10JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4285-10ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4285-10JI	J81	68-Lead Plastic Leaded Chip Carrier	
15	CY7C4285-15ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4285-15JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4285-15ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4285-15JI	J81	68-Lead Plastic Leaded Chip Carrier	
25	CY7C4285-25ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4285-25JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4285-25ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4285-25JI	J81	68-Lead Plastic Leaded Chip Carrier	
35	CY7C4285-35ASC	A64	64-Lead 10x10 Thin Quad Flatpack	Commercial
	CY7C4285-35JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C4285-35ASI	A64	64-Lead 10x10 Thin Quad Flatpack	Industrial
	CY7C4285-35JI	J81	68-Lead Plastic Leaded Chip Carrier	

Package Diagrams
64-Pin Thin Quad Flat Pack A64

68-Lead Plastic Leaded Chip Carrier J81
